

CGB3B3X6S0G225K055AB

TDK Item Description : CGB3B3X6S0G225KT****



Application & Main Feature

Commercial Grade (Low Profile)

Series

CGB3(1608) [EIA CC0603]



Dimensions

L 1.60mm +/-0.1mm
 W 0.80mm +/-0.1mm
 T 0.55mm Max.
 B 0.20mm Min.
 G 0.30mm Min.

Temperature Characteristic

X6S (-55 to 105 degC +/-22%)

Rated Voltage

0G (4Vdc)

Capacitance

2.2uF

Capacitance Tolerance

K (+/-10%)

Dissipation Factor

10% Max.

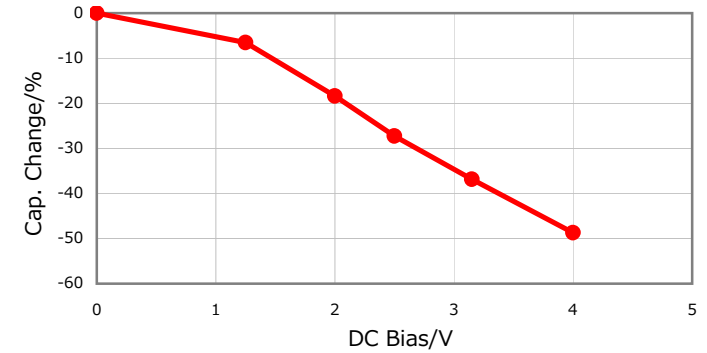
Insulation Resistance

45Mohm Min.

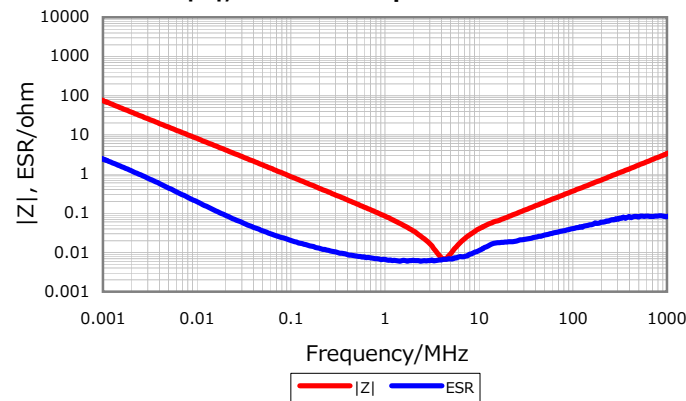
AEC-Q200

Not Applicable

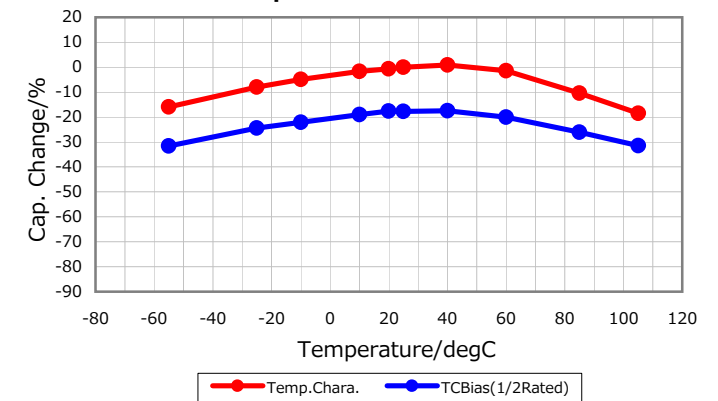
DC Bias Characteristic



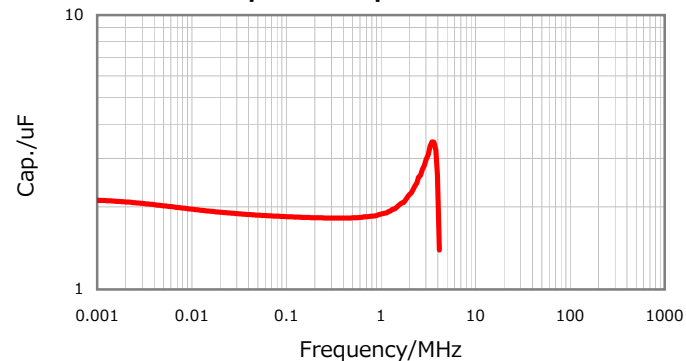
|Z|, ESR vs. Freq. Characteristics



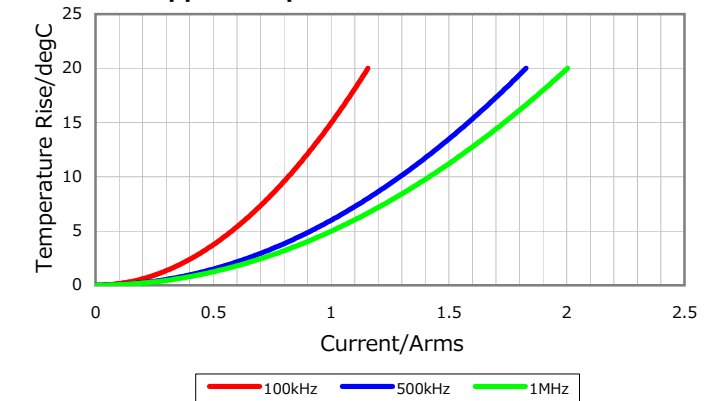
Temperature Characteristics



Cap. vs. Freq. Characteristic



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

January 4, 2016